

# Semiconductor Wafer Bonding Equipment Market, Global Outlook and Forecast 2022-2028

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### **Abstracts**

This report contains market size and forecasts of Semiconductor Wafer Bonding Equipment in global, including the following market information:

Global Semiconductor Wafer Bonding Equipment Market Revenue, 2017-2022, 2023-2028, (\$ millions)

Global Semiconductor Wafer Bonding Equipment Market Sales, 2017-2022, 2023-2028, (K Units)

Global top five Semiconductor Wafer Bonding Equipment companies in 2021 (%)

The global Semiconductor Wafer Bonding Equipment market was valued at million in 2021 and is projected to reach US\$ million by 2028, at a CAGR of % during the forecast period 2022-2028.

The U.S. Market is Estimated at \$ Million in 2021, While China is Forecast to Reach \$ Million by 2028.

Wire Bonder Segment to Reach \$ Million by 2028, with a % CAGR in next six years.

The global key manufacturers of Semiconductor Wafer Bonding Equipment include ASM Pacific Technology, Besi, DIAS Automation, F&K Delvotec Bondtechnik, FASFORD TECHNOLOGY, Hesse, Hybond, Kulicke& Soffa and Palomar Technologies, etc. In 2021, the global top five players have a share approximately % in terms of revenue.



MARKET MONITOR GLOBAL, INC (MMG) has surveyed the Semiconductor Wafer Bonding Equipment manufacturers, suppliers, distributors and industry experts on this industry, involving the sales, revenue, demand, price change, product type, recent development and plan, industry trends, drivers, challenges, obstacles, and potential risks.

Total Market by Segment:

Global Semiconductor Wafer Bonding Equipment Market, by Type, 2017-2022, 2023-2028 (\$ Millions) & (K Units)

Global Semiconductor Wafer Bonding Equipment Market Segment Percentages, by Type, 2021 (%)

Wire Bonder

Die Bonder

Global Semiconductor Wafer Bonding Equipment Market, by Application, 2017-2022, 2023-2028 (\$ Millions) & (K Units)

Global Semiconductor Wafer Bonding Equipment Market Segment Percentages, by Application, 2021 (%)

**IDM** 

**OSAT** 

Global Semiconductor Wafer Bonding Equipment Market, By Region and Country, 2017-2022, 2023-2028 (\$ Millions) & (K Units)

Global Semiconductor Wafer Bonding Equipment Market Segment Percentages, By Region and Country, 2021 (%)

North America

US



Canada

	Mexico	
Europe		
	Germany	
	France	
	U.K.	
	Italy	
	Russia	
	Nordic Countries	
	Benelux	
	Rest of Europe	
Asia		
	China	
	Japan	
	South Korea	
	Southeast Asia	
	India	
	Rest of Asia	
South America		



Brazil		
Argentina		
Rest of South America		
Middle East & Africa		
Turkey		
Israel		
Saudi Arabia		
UAE		
Rest of Middle East & Africa		
Competitor Analysis		
The report also provides analysis of leading market participants including:		
Key companies Semiconductor Wafer Bonding Equipment revenues in global market, 2017-2022 (Estimated), (\$ millions)		
Key companies Semiconductor Wafer Bonding Equipment revenues share in global market, 2021 (%)		
Key companies Semiconductor Wafer Bonding Equipment sales in global market, 2017-2022 (Estimated), (K Units)		
Key companies Semiconductor Wafer Bonding Equipment sales share in global marke 2021 (%)		
Further, the report presents profiles of competitors in the market, key players include:		

ASM Pacific Technology



Besi	
DIAS Automation	
F&K Delvotec Bondtechnik	
FASFORD TECHNOLOGY	
Hesse	
Hybond	
Kulicke& Soffa	
Palomar Technologies	
Panasonic	
SHINKAWA Electric	
Toray Engineering	
West-Bond	



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